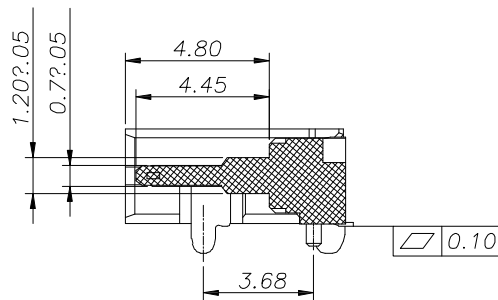
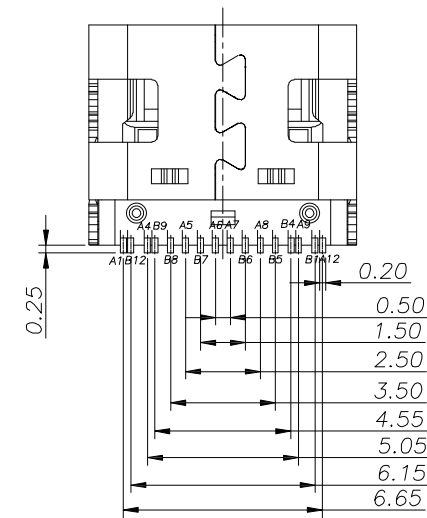
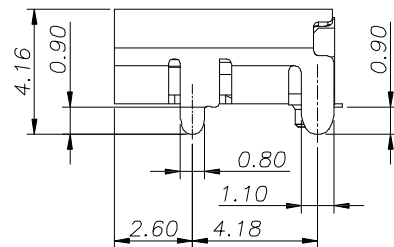
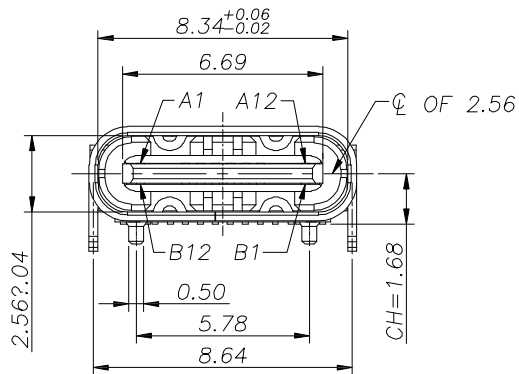
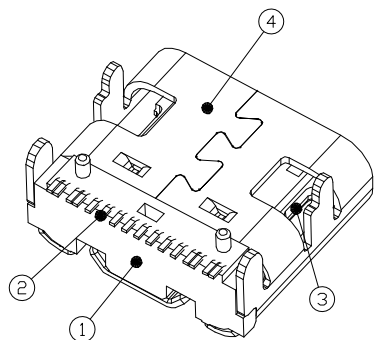
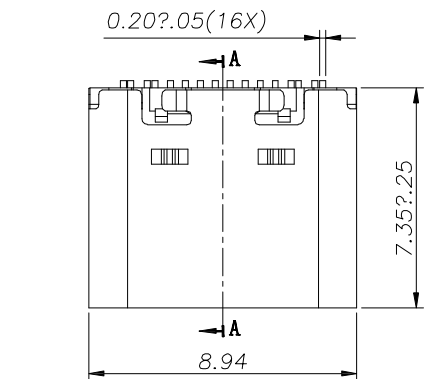


A
B
C
D
E
F
G
H
I
J



NOTE:

- 1.MATERIAL SPECIFICATION:
 - 1.HOUSING:HIGH TEMPERATURE RESISTANT PLASTIC,UL94 V-0.
 - 2.CONTACTS:COPPER ALLOY
 - 3.MID PLATE: STAINLESS STEEL
 - 4.FRONT SHELL: STAINLESS STEEL
- 2.PLATING SPECIFICATION:
 - 2-1.CONTACTS:
 - Ni 50u" MIN. UNDER PLATED OVER ALL.
 - Au PLATED ON THE FUNCTIONAL AREA OF CONTACT.
 - (GOLD PLATING THICKNESS FOLLOW THE P/N)
 - PLATING SPECIFICATIONS OF THE SOLDER AREA FOLLOW THE P/N
 - 2-2.FRONT SHELL:
 - Ni 30u" MIN. UNDER PLATED OVER ALL.
 - 2-3.SHIELD PLATE&EMI PLATE:
 - CLEAR ONLY
- 3.MECHANICAL PERFORMANCE,
 - 3-1.INSERTION FORCE: 0.5~2.0kgf.
 - 3-2.REMOVAL FORCE: 0.8kgf~2.0kgf.
 - 3-3.DURABILITY: 10000 CYCLES.
- 4.ELECTRICAL PERFORMANCE,
 - 4-1. CURRENT RATING:5.0A
VOLTAGE RATING:5.0V
 - 4-2. LLCR:
 - VBUS & GND PINS AND OTHER PINS: 40mΩ/PIN MAX.
 - SHIELD: 50mΩ/MAX.
 - LLCR MAX. CHANGE OF ALL PINS: 10mΩ.
 - 4-3.INSULATION RESISTANCE: 100MΩ MIN
 - 4-4.DIELECTRIC WITHSTAND VOLTAGE,AC 100V FOR 1 MINUTE.
5. ENVIRONMENTAL PERFORMANCE:
 - OPERATING TEMPERATURE: -25~+85
- 6.IR REFLOW:
 - THE PEAK TEMPERATURE ON THE BOARD SHALL BE MAINTAINED FOR 10 SECONDS AT 260°C.

MARK	DESCRIPTION	DATE	REVISED	APPROVED
REVISIONS				

unless otherwise specified tolerance:
 X.X ±0.30 X.' ±10'
 .XX ±0.20 .X' ± 8'
 .XXX ±0.10 .XX' ± 5'

DSND	HUANGJM	DATE	2018-1-18	SCALE:	
CHKD				VIEW:	
APVD				UNIT:	mm

Dongguan Fushu Electronic Technology Co.,Ltd
 Tel:0755-81765247/41 Fax:0769-81765203
 FSCONN.

NAME: USB CF 16PIN (L=7.35) WITH POST
 Part No: ZUC-F16P
 Customer Part NO:(DWG NO.)